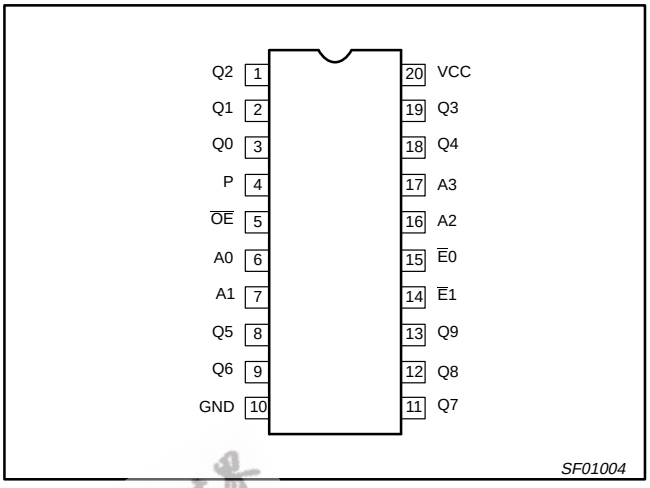
1-of-10 decoder (3-State) 74F537

DESCRIPTION

The 74F537 is a one-of-ten decoder/demultiplexer with four active High BCD inputs and ten mutually exclusive outputs. A Polarity control (P) input determines whether the outputs are active Low or active High. The 74F537 has 3-State outputs and a High signal on the Output Enables ($\overline{OE}$) input forces all outputs to the high impedance state. Two input Enables, active High (E1) and active Low ($\overline{E}0$), are available for demultiplexing data to the selected output in either non-inverted or inverted form. Input codes greater than BCD nine causes all outputs to go to the inactive state (i.e., same polarity as the P input).

TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F537	9ns	44mA

PIN CONFIGURATION



ORDERING INFORMATION

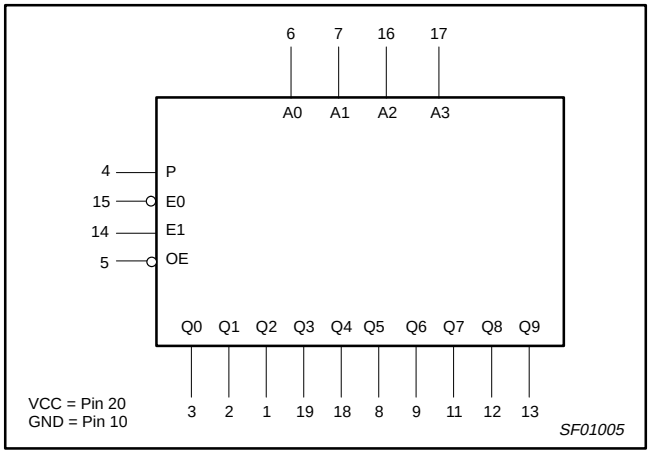
DESCRIPTION	COMMERCIAL RANGE V_{CC} = 5V ±10%, T_{amb} = 0°C to +70°C
20-Pin Plastic DIP	N74F537N
20-Pin Plastic SOL	N74F537D

INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

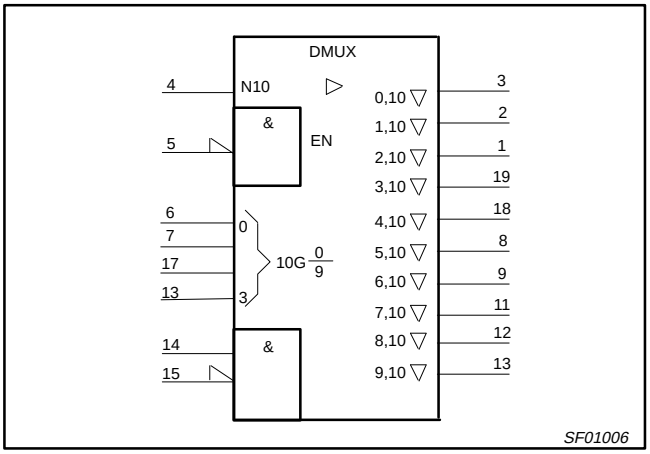
PINS	DESCRIPTION	74F(U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
A0 - A3	Data inputs	1.0/1.0	20µA/0.6mA
$\overline{E}0$	Enable input (active Low)	1.0/1.0	20µA/0.6mA
E1	Enable input (active High)	1.0/1.0	20µA/0.6mA
P	Polarity control input	1.0/1.0	20µA/0.6mA
$\overline{OE}$	Output Enable input	1.0/1.0	20µA/0.6mA
Q0 - Q9	Data outputs	150/40	3.0mA/24mA

NOTE: One (1.0) FAST Unit Load is defined as: 20µA in the High state and 0.6mA in the Low state.

LOGIC SYMBOL

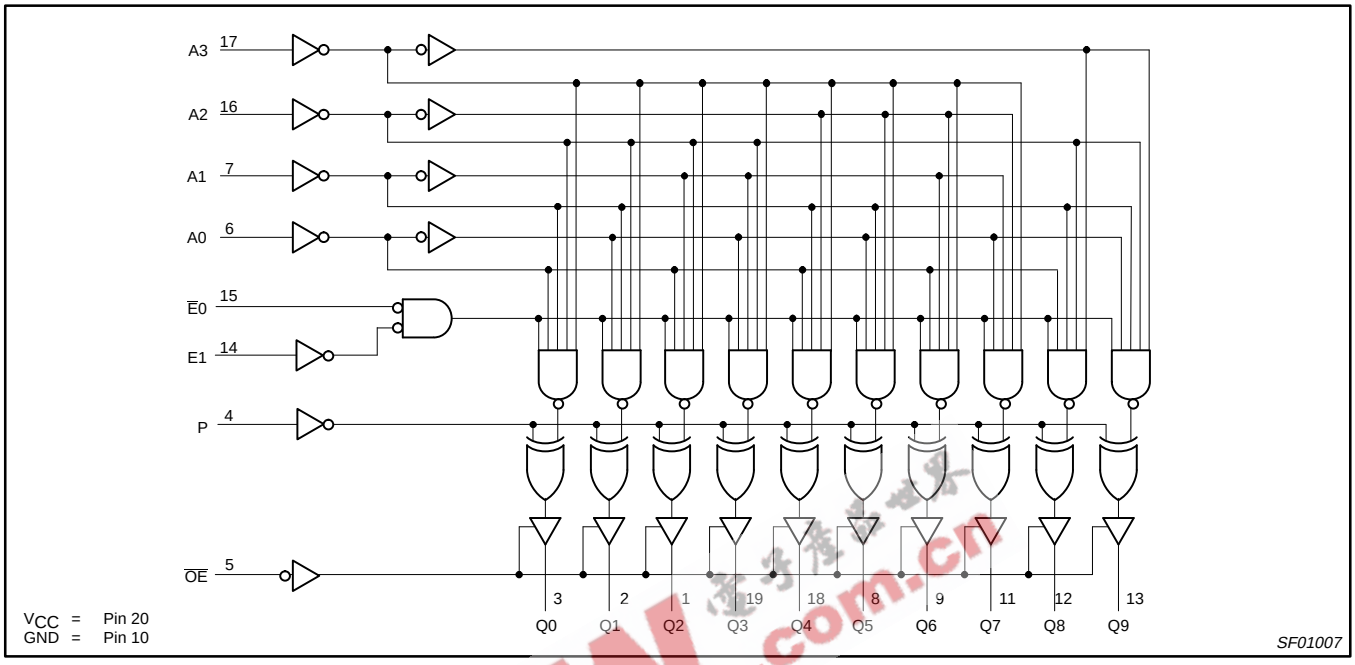


LOGIC SYMBOL (IEEE/IEC)



1-of-10 decoder (3-State) 74F537

LOGIC DIAGRAM



FUNCTION TABLE

INPUTS							OUTPUTS										OPERATING MODE
$\overline{OE}$	$\overline{E}0$	E1	A3	A2	A1	A0	Q0	Q1	Q2	Q3	Q4	Q5	Q6	Q7	Q8	Q9	
H	X	X	X	X	X	X	Z	Z	Z	Z	Z	Z	Z	Z	Z	Z	High Impedance
L	H	X	X	X	X	X	Outputs equal P input										Disable
L	X	L	X	X	X	X											
L	L	H	L	L	L	L	H	L	L	L	L	L	L	L	L	L	Active High output (P = L)
L	L	H	L	L	L	H	L	H	L	L	L	L	L	L	L	L	
L	L	H	L	L	H	L	L	L	H	L	L	L	L	L	L	L	
L	L	H	L	L	H	H	L	L	L	H	L	L	L	L	L	L	
L	L	H	L	H	L	L	L	L	L	L	H	L	L	L	L	L	
L	L	H	L	H	L	H	L	L	L	L	L	H	L	L	L	L	
L	L	H	L	H	H	L	L	L	L	L	L	L	H	L	L	L	
L	L	H	L	H	H	H	L	L	L	L	L	L	L	H	L	L	
L	L	H	H	L	L	L	L	L	L	L	L	L	L	L	H	L	
L	L	H	H	L	L	H	L	L	L	L	L	L	L	L	L	H	
L	L	H	H	X	H	X	L	L	L	L	L	L	L	L	L	L	
L	L	H	H	L	X	X	L	L	L	L	L	L	L	L	L	L	
L	L	H	L	L	L	L	L	H	H	H	H	H	H	H	H	H	Active Low output (P = H)
L	L	H	L	L	L	H	H	L	H	H	H	H	H	H	H	H	
L	L	H	L	L	H	L	H	H	L	H	H	H	H	H	H	H	
L	L	H	L	L	H	H	H	H	H	L	H	H	H	H	H	H	
L	L	H	L	H	L	L	H	H	H	H	L	H	H	H	H	H	
L	L	H	L	H	L	H	H	H	H	H	H	L	H	H	H	H	
L	L	H	L	H	H	L	H	H	H	H	H	H	L	H	H	H	
L	L	H	L	H	H	H	H	H	H	H	H	H	H	L	H	H	
L	L	H	H	L	L	L	H	H	H	H	H	H	H	H	L	H	
L	L	H	H	L	L	H	H	H	H	H	H	H	H	H	H	L	
L	L	H	H	X	H	X	H	H	H	H	H	H	H	H	H	H	
L	L	H	H	H	X	X	H	H	H	H	H	H	H	H	H	H	

H = High voltage level
L = Low voltage level
X = Don't care
Z = High impedance "off" state

ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limits set forth in this table may impair the useful life of the device.
Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V_{CC}	Supply voltage	–0.5 to +7.0	V
V_{IN}	Input voltage	–0.5 to +7.0	V
I_{IN}	Input current	–30 to +5.0	mA
V_{OUT}	Voltage applied to output in High output state	–0.5 to +V_{CC}	V
I_{OUT}	Current applied to output in Low output state	48	mA
T_{amb}	Operating free-air temperature range	0 to +70	°C
T_{stg}	Storage temperature	–65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS			UNIT
		MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5.0	5.5	V
V_{IH}	High-level input voltage	2.0			V
V_{IL}	Low-level input voltage			0.8	V
I_{IK}	Input clamp current			–18	mA
I_{OH}	High-level output current			–3.0	mA
I_{OL}	Low-level output current			24	mA
T_{amb}	Operating free-air temperature range	0		70	°C

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER	TEST CONDITIONS[1]		LIMITS			UNIT
				MIN	TYP[2]	MAX	
V_{OH}	High-level output voltage	V_{CC} = MIN, V_{IL} = MAX, V_{IH} = MIN, I_{OH} = MAX	±10%V_{CC}	2.4			V
			±5%V_{CC}	2.7	3.3		V
V_{OL}	Low-level output voltage	V_{CC} = MIN, V_{IL} = MAX, V_{IH} = MIN, I_{OL} = MAX	±10%V_{CC}		0.35	0.50	V
			±5%V_{CC}		0.35	0.50	V
V_{IK}	Input clamp voltage	V_{CC} = MIN, I_I = I_{IK}			–0.73	–1.2	V
I_I	Input current at maximum input voltage	V_{CC} = MAX, V_I = 7.0V				100	µA
I_{IH}	High-level input current	V_{CC} = MAX, V_I = 2.7V				20	µA
I_{IL}	Low-level input current	V_{CC} = MAX, V_I = 0.5V				–0.6	mA
I_{OZH}	Off-state current High-level voltage applied	V_{CC} = MAX, V_O = 2.7V				50	µA
I_{OZL}	Off-state current Low-level voltage applied	V_{CC} = MAX, V_O = 0.5V				–50	µA
I_{OS}	Short-circuit output current[3]	V_{CC} = MAX		–60		–150	mA
I_{CC}	Supply current (total)	V_{CC} = MAX			44	66	mA

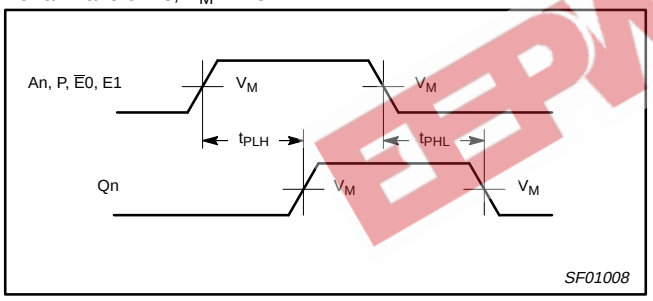
NOTES:
1. For conditions shown as MIN or MAX, use the appropriate value under the recommended operating conditions for the applicable type.
2. All typical values are at V_{CC} = 5V, T_{amb} = 25°C.
3. Not more than one output should be shorted at a time. For testing I_{OS}, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} should be performed last.

AC ELECTRICAL CHARACTERISTICS

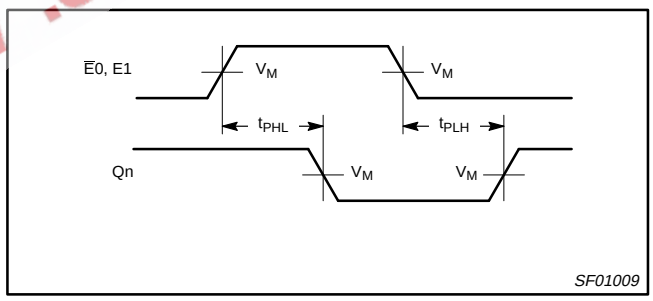
SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS					UNIT
			T_{amb} = +25°C, V_{CC} = +5.0V, C_L = 50pF, R_L = 500Ω			T_{amb} = 0°C to +70°C, V_{CC} = +5.0V ± 10%, C_L = 50pF, R_L = 500Ω		
			MIN	TYP	MAX	MIN	MAX	
t_{PLH} t_{PHL}	Propagation delay An to Qn	Waveform 1	4.5 3.0	9.0 7.5	14.0 11.0	4.5 3.0	16.0 12.0	ns ns
t_{PLH} t_{PHL}	Propagation delay $\overline{E}0$ to Qn	Waveform 2	4.0 3.0	8.0 8.0	11.0 11.0	4.0 3.0	12.0 12.0	ns ns
t_{PLH} t_{PHL}	Propagation delay E1 to Qn	Waveform 2	6.0 4.0	8.5 8.5	11.5 11.5	6.0 4.0	13.0 12.5	ns ns
t_{PLH} t_{PHL}	Propagation delay P to Qn	Waveform 1	5.0 3.5	12.5 6.5	16.0 10.0	5.0 3.5	17.0 11.0	ns ns
t_{PZH} t_{PZL}	Output Enable time $\overline{OE}$ to Qn	Waveform 3 Waveform 4	2.5 4.0	4.5 5.5	7.0 8.0	2.5 4.0	8.0 9.0	ns ns
t_{PHZ} t_{PLZ}	Output Disable time $\overline{OE}$ to Qn	Waveform 3 Waveform 4	1.5 2.0	3.0 4.0	6.0 6.5	1.0 2.0	7.0 7.0	ns ns

AC WAVEFORMS

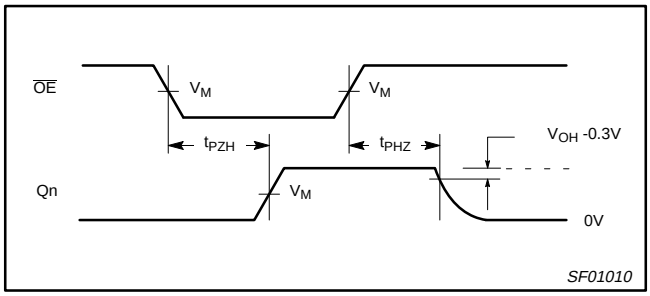
For all waveforms, V_M = 1.5V.



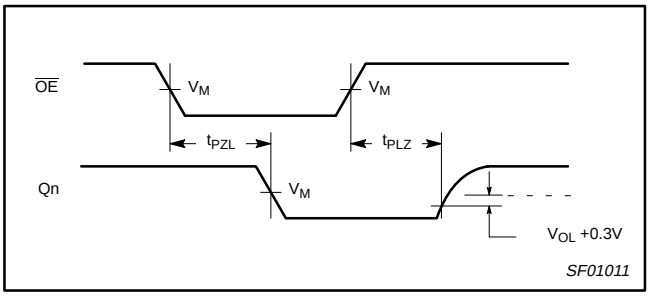
Waveform 1. Propagation Delay for Non-Inverting Outputs



Waveform 2. Propagation Delay for Inverting Outputs

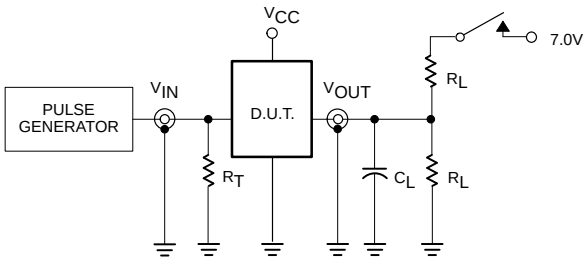


Waveform 3. 3-State Output Enable Time to High Level and Output Disable Time from High Level



Waveform 4. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level

TEST CIRCUIT AND WAVEFORM



Test Circuit for 3-State Outputs

SWITCH POSITION

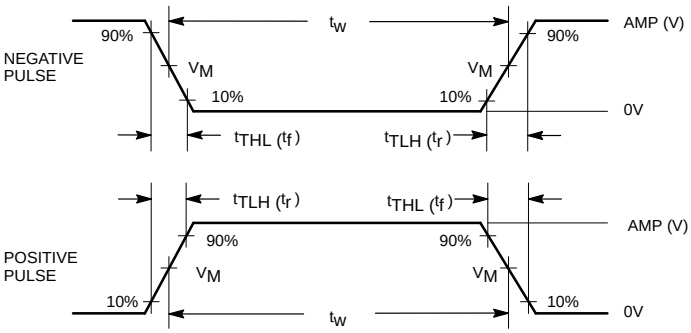
TEST	SWITCH
t_{PLZ}	closed
t_{PZL}	closed
All other	open

DEFINITIONS:

R_L = Load resistor;
see AC electrical characteristics for value.

C_L = Load capacitance includes jig and probe capacitance;
see AC electrical characteristics for value.

R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.



Input Pulse Definition

family	INPUT PULSE REQUIREMENTS					
	amplitude	V_M	rep. rate	t_w	t_{TLH}	t_{THL}
74F	3.0V	1.5V	1MHz	500ns	2.5ns	2.5ns

SF00777